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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 359200  |
| Number of Logic Elements/Cells | 952000  |
| Total RAM Bits                 | 53248000  |
| Number of I/O                  | 840   |
| Number of Gates                | -   |
| Voltage - Supply               | 0.82V ~ 0.88V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | 0°C ~ 85°C (TJ)   |
| Package / Case                 | 1932-BBGA, FCBGA  |
| Supplier Device Package        | 1932-FBGA, FC (45x45)   |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/5sgxmabn3f45c2ln">https://www.e-xfl.com/product-detail/intel/5sgxmabn3f45c2ln</a> |

**Table 1. Stratix V GX and GS Commercial and Industrial Speed Grade Offering <sup>(1), (2), (3)</sup> (Part 2 of 2)**

| Transceiver Speed Grade  | Core Speed Grade |         |     |     |         |         |                    |     |
|--------------------------|------------------|---------|-----|-----|---------|---------|--------------------|-----|
|                          | C1               | C2, C2L | C3  | C4  | I2, I2L | I3, I3L | I3YY               | I4  |
| 3<br>GX channel—8.5 Gbps | —                | Yes     | Yes | Yes | —       | Yes     | Yes <sup>(4)</sup> | Yes |

**Notes to Table 1:**

- (1) C = Commercial temperature grade; I = Industrial temperature grade.  
 (2) Lower number refers to faster speed grade.  
 (3) C2L, I2L, and I3L speed grades are for low-power devices.  
 (4) I3YY speed grades can achieve up to 10.3125 Gbps.

Table 2 lists the industrial and commercial speed grades for the Stratix V GT devices.

**Table 2. Stratix V GT Commercial and Industrial Speed Grade Offering <sup>(1), (2)</sup>**

| Transceiver Speed Grade                            | Core Speed Grade |     |     |     |
|--|------------------|-----|-----|-----|
|  | C1               | C2  | I2  | I3  |
| 2<br>GX channel—12.5 Gbps<br>GT channel—28.05 Gbps | Yes              | Yes | —   | —   |
| 3<br>GX channel—12.5 Gbps<br>GT channel—25.78 Gbps | Yes              | Yes | Yes | Yes |

**Notes to Table 2:**

- (1) C = Commercial temperature grade; I = Industrial temperature grade.  
 (2) Lower number refers to faster speed grade.

**Absolute Maximum Ratings**

Absolute maximum ratings define the maximum operating conditions for Stratix V devices. The values are based on experiments conducted with the devices and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied for these conditions.



Conditions other than those listed in Table 3 may cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.

**Table 3. Absolute Maximum Ratings for Stratix V Devices (Part 1 of 2)**

| Symbol              | Description  | Minimum | Maximum | Unit |
|---------------------|--|---------|---------|------|
| V <sub>CC</sub>     | Power supply for core voltage and periphery circuitry                  | −0.5    | 1.35    | V    |
| V <sub>CCPT</sub>   | Power supply for programmable power technology                         | −0.5    | 1.8     | V    |
| V <sub>CCPGM</sub>  | Power supply for configuration pins                                    | −0.5    | 3.9     | V    |
| V <sub>CC_AUX</sub> | Auxiliary supply for the programmable power technology                 | −0.5    | 3.4     | V    |
| V <sub>CCBAT</sub>  | Battery back-up power supply for design security volatile key register | −0.5    | 3.9     | V    |
| V <sub>CCPD</sub>   | I/O pre-driver power supply  | −0.5    | 3.9     | V    |
| V <sub>CCIO</sub>   | I/O power supply   | −0.5    | 3.9     | V    |

**Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 2 of 2)**

| Symbol               | Description  | Conditions                        | Resistance Tolerance |        |              |        | Unit |
|----------------------|--|-----------------------------------|----------------------|--------|--------------|--------|------|
|                      |  |                                   | C1                   | C2, I2 | C3, I3, I3YY | C4, I4 |      |
| 50-Ω R <sub>S</sub>  | Internal series termination without calibration (50-Ω setting) | V <sub>CCIO</sub> = 1.8 and 1.5 V | ±30                  | ±30    | ±40          | ±40    | %    |
| 50-Ω R <sub>S</sub>  | Internal series termination without calibration (50-Ω setting) | V <sub>CCIO</sub> = 1.2 V         | ±35                  | ±35    | ±50          | ±50    | %    |
| 100-Ω R <sub>D</sub> | Internal differential termination (100-Ω setting)              | V <sub>CCPD</sub> = 2.5 V         | ±25                  | ±25    | ±25          | ±25    | %    |

Calibration accuracy for the calibrated series and parallel OCTs are applicable at the moment of calibration. When voltage and temperature conditions change after calibration, the tolerance may change.

OCT calibration is automatically performed at power-up for OCT-enabled I/Os. Table 13 lists the OCT variation with temperature and voltage after power-up calibration. Use Table 13 to determine the OCT variation after power-up calibration and Equation 1 to determine the OCT variation without recalibration.

**Equation 1. OCT Variation Without Recalibration for Stratix V Devices <sup>(1), (2), (3), (4), (5), (6)</sup>**

$$R_{OCT} = R_{SCAL} \left( 1 + \left\langle \frac{dR}{dT} \times \Delta T \right\rangle \pm \left\langle \frac{dR}{dV} \times \Delta V \right\rangle \right)$$

**Notes to Equation 1:**

- (1) The R<sub>OCT</sub> value shows the range of OCT resistance with the variation of temperature and V<sub>CCIO</sub>.
- (2) R<sub>SCAL</sub> is the OCT resistance value at power-up.
- (3) ΔT is the variation of temperature with respect to the temperature at power-up.
- (4) ΔV is the variation of voltage with respect to the V<sub>CCIO</sub> at power-up.
- (5) dR/dT is the percentage change of R<sub>SCAL</sub> with temperature.
- (6) dR/dV is the percentage change of R<sub>SCAL</sub> with voltage.

Table 13 lists the on-chip termination variation after power-up calibration.

**Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 1 of 2) <sup>(1)</sup>**

| Symbol | Description                                      | V <sub>CCIO</sub> (V) | Typical | Unit   |
|--------|--|-----------------------|---------|--------|
| dR/dV  | OCT variation with voltage without recalibration | 3.0                   | 0.0297  | % / mV |
|        |  | 2.5                   | 0.0344  |        |
|        |  | 1.8                   | 0.0499  |        |
|        |  | 1.5                   | 0.0744  |        |
|        |  | 1.2                   | 0.1241  |        |

**Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 2 of 2) <sup>(1)</sup>**

| Symbol | Description  | V <sub>CCIO</sub> (V) | Typical | Unit              |
|--------|--|-----------------------|---------|-------------------|
| dR/dT  | OCT variation with temperature without recalibration | 3.0                   | 0.189   | %/ <sup>o</sup> C |
|        |  | 2.5                   | 0.208   |                   |
|        |  | 1.8                   | 0.266   |                   |
|        |  | 1.5                   | 0.273   |                   |
|        |  | 1.2                   | 0.317   |                   |

**Note to Table 13:**

(1) Valid for a V<sub>CCIO</sub> range of  $\pm 5\%$  and a temperature range of 0° to 85°C.

**Pin Capacitance**

Table 14 lists the Stratix V device family pin capacitance.

**Table 14. Pin Capacitance for Stratix V Devices**

| Symbol             | Description  | Value | Unit |
|--------------------|--|-------|------|
| C <sub>IOTB</sub>  | Input capacitance on the top and bottom I/O pins                 | 6     | pF   |
| C <sub>IOLR</sub>  | Input capacitance on the left and right I/O pins                 | 6     | pF   |
| C <sub>OUTFB</sub> | Input capacitance on dual-purpose clock output and feedback pins | 6     | pF   |

**Hot Socketing**

Table 15 lists the hot socketing specifications for Stratix V devices.

**Table 15. Hot Socketing Specifications for Stratix V Devices**

| Symbol                    | Description                                | Maximum             |
|---------------------------|--|---------------------|
| I <sub>IOPIN</sub> (DC)   | DC current per I/O pin                     | 300 $\mu$ A         |
| I <sub>IOPIN</sub> (AC)   | AC current per I/O pin                     | 8 mA <sup>(1)</sup> |
| I <sub>XCVR-TX</sub> (DC) | DC current per transceiver transmitter pin | 100 mA              |
| I <sub>XCVR-RX</sub> (DC) | DC current per transceiver receiver pin    | 50 mA               |

**Note to Table 15:**

(1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns,  $|I_{IOPIN}| = C \, dv/dt$ , in which C is the I/O pin capacitance and dv/dt is the slew rate.

## Internal Weak Pull-Up Resistor

Table 16 lists the weak pull-up resistor values for Stratix V devices.

**Table 16. Internal Weak Pull-Up Resistor for Stratix V Devices <sup>(1), (2)</sup>**

| Symbol          | Description   | V <sub>CCIO</sub> Conditions (V) <sup>(3)</sup> | Value <sup>(4)</sup> | Unit |
|-----------------|---|---|----------------------|------|
| R <sub>PU</sub> | Value of the I/O pin pull-up resistor before and during configuration, as well as user mode if you enable the programmable pull-up resistor option. | 3.0 ±5%   | 25                   | kΩ   |
|                 |   | 2.5 ±5%   | 25                   | kΩ   |
|                 |   | 1.8 ±5%   | 25                   | kΩ   |
|                 |   | 1.5 ±5%   | 25                   | kΩ   |
|                 |   | 1.35 ±5%  | 25                   | kΩ   |
|                 |   | 1.25 ±5%  | 25                   | kΩ   |
|                 |   | 1.2 ±5%   | 25                   | kΩ   |

### Notes to Table 16:

- (1) All I/O pins have an option to enable the weak pull-up resistor except the configuration, test, and JTAG pins.
- (2) The internal weak pull-down feature is only available for the JTAG TCK pin. The typical value for this internal weak pull-down resistor is approximately 25 kΩ.
- (3) The pin pull-up resistance values may be lower if an external source drives the pin higher than V<sub>CCIO</sub>.
- (4) These specifications are valid with a ±10% tolerance to cover changes over PVT.

## I/O Standard Specifications

Table 17 through Table 22 list the input voltage (V<sub>IH</sub> and V<sub>IL</sub>), output voltage (V<sub>OH</sub> and V<sub>OL</sub>), and current drive characteristics (I<sub>OH</sub> and I<sub>OL</sub>) for various I/O standards supported by Stratix V devices. These tables also show the Stratix V device family I/O standard specifications. The V<sub>OL</sub> and V<sub>OH</sub> values are valid at the corresponding I<sub>OH</sub> and I<sub>OL</sub>, respectively.

For an explanation of the terms used in Table 17 through Table 22, refer to “Glossary” on page 65. For tolerance calculations across all SSTL and HSTL I/O standards, refer to Altera knowledge base solution rd07262012\_486.

**Table 17. Single-Ended I/O Standards for Stratix V Devices**

| I/O Standard | V <sub>CCIO</sub> (V) |     |       | V <sub>IL</sub> (V) |                             | V <sub>IH</sub> (V)         |                         | V <sub>OL</sub> (V)         | V <sub>OH</sub> (V)         | I <sub>OL</sub> (mA) | I <sub>OH</sub> (mA) |
|--------------|-----------------------|-----|-------|---------------------|-----------------------------|-----------------------------|-------------------------|-----------------------------|-----------------------------|----------------------|----------------------|
|              | Min                   | Typ | Max   | Min                 | Max                         | Min                         | Max                     | Max                         | Min                         |                      |                      |
| LVTTTL       | 2.85                  | 3   | 3.15  | −0.3                | 0.8                         | 1.7                         | 3.6                     | 0.4                         | 2.4                         | 2                    | −2                   |
| LVC MOS      | 2.85                  | 3   | 3.15  | −0.3                | 0.8                         | 1.7                         | 3.6                     | 0.2                         | V <sub>CCIO</sub> − 0.2     | 0.1                  | −0.1                 |
| 2.5 V        | 2.375                 | 2.5 | 2.625 | −0.3                | 0.7                         | 1.7                         | 3.6                     | 0.4                         | 2                           | 1                    | −1                   |
| 1.8 V        | 1.71                  | 1.8 | 1.89  | −0.3                | 0.35 *<br>V <sub>CCIO</sub> | 0.65 *<br>V <sub>CCIO</sub> | V <sub>CCIO</sub> + 0.3 | 0.45                        | V <sub>CCIO</sub> − 0.45    | 2                    | −2                   |
| 1.5 V        | 1.425                 | 1.5 | 1.575 | −0.3                | 0.35 *<br>V <sub>CCIO</sub> | 0.65 *<br>V <sub>CCIO</sub> | V <sub>CCIO</sub> + 0.3 | 0.25 *<br>V <sub>CCIO</sub> | 0.75 *<br>V <sub>CCIO</sub> | 2                    | −2                   |
| 1.2 V        | 1.14                  | 1.2 | 1.26  | −0.3                | 0.35 *<br>V <sub>CCIO</sub> | 0.65 *<br>V <sub>CCIO</sub> | V <sub>CCIO</sub> + 0.3 | 0.25 *<br>V <sub>CCIO</sub> | 0.75 *<br>V <sub>CCIO</sub> | 2                    | −2                   |

**Table 18. Single-Ended SSTL, HSTL, and HSUL I/O Reference Voltage Specifications for Stratix V Devices**

| I/O Standard            | $V_{CCIO}$ (V) |      |       | $V_{REF}$ (V)     |                  |                   | $V_{TT}$ (V)      |                  |                   |
|-------------------------|----------------|------|-------|-------------------|------------------|-------------------|-------------------|------------------|-------------------|
|                         | Min            | Typ  | Max   | Min               | Typ              | Max               | Min               | Typ              | Max               |
| SSTL-2<br>Class I, II   | 2.375          | 2.5  | 2.625 | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $V_{REF} - 0.04$  | $V_{REF}$        | $V_{REF} + 0.04$  |
| SSTL-18<br>Class I, II  | 1.71           | 1.8  | 1.89  | 0.833             | 0.9              | 0.969             | $V_{REF} - 0.04$  | $V_{REF}$        | $V_{REF} + 0.04$  |
| SSTL-15<br>Class I, II  | 1.425          | 1.5  | 1.575 | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ |
| SSTL-135<br>Class I, II | 1.283          | 1.35 | 1.418 | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ |
| SSTL-125<br>Class I, II | 1.19           | 1.25 | 1.26  | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ |
| SSTL-12<br>Class I, II  | 1.14           | 1.20 | 1.26  | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ |
| HSTL-18<br>Class I, II  | 1.71           | 1.8  | 1.89  | 0.85              | 0.9              | 0.95              | —                 | $V_{CCIO}/2$     | —                 |
| HSTL-15<br>Class I, II  | 1.425          | 1.5  | 1.575 | 0.68              | 0.75             | 0.9               | —                 | $V_{CCIO}/2$     | —                 |
| HSTL-12<br>Class I, II  | 1.14           | 1.2  | 1.26  | $0.47 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.53 * V_{CCIO}$ | —                 | $V_{CCIO}/2$     | —                 |
| HSUL-12                 | 1.14           | 1.2  | 1.3   | $0.49 * V_{CCIO}$ | $0.5 * V_{CCIO}$ | $0.51 * V_{CCIO}$ | —                 | —                | —                 |

**Table 19. Single-Ended SSTL, HSTL, and HSUL I/O Standards Signal Specifications for Stratix V Devices (Part 1 of 2)**

| I/O Standard            | $V_{IL(DC)}$ (V) |                   | $V_{IH(DC)}$ (V)  |                  | $V_{IL(AC)}$ (V)  | $V_{IH(AC)}$ (V)  | $V_{OL}$ (V)     | $V_{OH}$ (V)      | $I_{OI}$ (mA) | $I_{OH}$ (mA) |
|-------------------------|------------------|-------------------|-------------------|------------------|-------------------|-------------------|------------------|-------------------|---------------|---------------|
|                         | Min              | Max               | Min               | Max              | Max               | Min               | Max              | Min               |               |               |
| SSTL-2<br>Class I       | -0.3             | $V_{REF} - 0.15$  | $V_{REF} + 0.15$  | $V_{CCIO} + 0.3$ | $V_{REF} - 0.31$  | $V_{REF} + 0.31$  | $V_{TT} - 0.608$ | $V_{TT} + 0.608$  | 8.1           | -8.1          |
| SSTL-2<br>Class II      | -0.3             | $V_{REF} - 0.15$  | $V_{REF} + 0.15$  | $V_{CCIO} + 0.3$ | $V_{REF} - 0.31$  | $V_{REF} + 0.31$  | $V_{TT} - 0.81$  | $V_{TT} + 0.81$   | 16.2          | -16.2         |
| SSTL-18<br>Class I      | -0.3             | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | $V_{CCIO} + 0.3$ | $V_{REF} - 0.25$  | $V_{REF} + 0.25$  | $V_{TT} - 0.603$ | $V_{TT} + 0.603$  | 6.7           | -6.7          |
| SSTL-18<br>Class II     | -0.3             | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | $V_{CCIO} + 0.3$ | $V_{REF} - 0.25$  | $V_{REF} + 0.25$  | 0.28             | $V_{CCIO} - 0.28$ | 13.4          | -13.4         |
| SSTL-15<br>Class I      | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —                | $V_{REF} - 0.175$ | $V_{REF} + 0.175$ | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | 8             | -8            |
| SSTL-15<br>Class II     | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —                | $V_{REF} - 0.175$ | $V_{REF} + 0.175$ | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | 16            | -16           |
| SSTL-135<br>Class I, II | —                | $V_{REF} - 0.09$  | $V_{REF} + 0.09$  | —                | $V_{REF} - 0.16$  | $V_{REF} + 0.16$  | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | —             | —             |
| SSTL-125<br>Class I, II | —                | $V_{REF} - 0.85$  | $V_{REF} + 0.85$  | —                | $V_{REF} - 0.15$  | $V_{REF} + 0.15$  | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | —             | —             |
| SSTL-12<br>Class I, II  | —                | $V_{REF} - 0.1$   | $V_{REF} + 0.1$   | —                | $V_{REF} - 0.15$  | $V_{REF} + 0.15$  | $0.2 * V_{CCIO}$ | $0.8 * V_{CCIO}$  | —             | —             |

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 2 of 7)**

| Symbol/<br>Description   | Conditions   | Transceiver Speed<br>Grade 1     |                   |      | Transceiver Speed<br>Grade 2     |                   |      | Transceiver Speed<br>Grade 3     |                   |      | Unit        |
|--|--|----------------------------------|-------------------|------|----------------------------------|-------------------|------|----------------------------------|-------------------|------|-------------|
|  |  | Min                              | Typ               | Max  | Min                              | Typ               | Max  | Min                              | Typ               | Max  |             |
| Spread-spectrum<br>downspread                                      | PCIe   | —                                | 0 to<br>-0.5      | —    | —                                | 0 to<br>-0.5      | —    | —                                | 0 to<br>-0.5      | —    | %           |
| On-chip<br>termination<br>resistors <sup>(21)</sup>                | —  | —                                | 100               | —    | —                                | 100               | —    | —                                | 100               | —    | $\Omega$    |
| Absolute $V_{MAX}$ <sup>(5)</sup>                                  | Dedicated<br>reference<br>clock pin                    | —                                | —                 | 1.6  | —                                | —                 | 1.6  | —                                | —                 | 1.6  | V           |
|  | RX reference<br>clock pin                              | —                                | —                 | 1.2  | —                                | —                 | 1.2  | —                                | —                 | 1.2  |             |
| Absolute $V_{MIN}$   | —  | -0.4                             | —                 | —    | -0.4                             | —                 | —    | -0.4                             | —                 | —    | V           |
| Peak-to-peak<br>differential input<br>voltage                      | —  | 200                              | —                 | 1600 | 200                              | —                 | 1600 | 200                              | —                 | 1600 | mV          |
| $V_{ICM}$ (AC<br>coupled) <sup>(3)</sup>                           | Dedicated<br>reference<br>clock pin                    | 1050/1000/900/850 <sup>(2)</sup> |                   |      | 1050/1000/900/850 <sup>(2)</sup> |                   |      | 1050/1000/900/850 <sup>(2)</sup> |                   |      | mV          |
|  | RX reference<br>clock pin                              | 1.0/0.9/0.85 <sup>(4)</sup>      |                   |      | 1.0/0.9/0.85 <sup>(4)</sup>      |                   |      | 1.0/0.9/0.85 <sup>(4)</sup>      |                   |      | V           |
| $V_{ICM}$ (DC coupled)   | HCSL I/O<br>standard for<br>PCIe<br>reference<br>clock | 250                              | —                 | 550  | 250                              | —                 | 550  | 250                              | —                 | 550  | mV          |
| Transmitter<br>REFCLK Phase<br>Noise<br>(622 MHz) <sup>(20)</sup>  | 100 Hz   | —                                | —                 | -70  | —                                | —                 | -70  | —                                | —                 | -70  | dBc/Hz      |
|  | 1 kHz  | —                                | —                 | -90  | —                                | —                 | -90  | —                                | —                 | -90  | dBc/Hz      |
|  | 10 kHz   | —                                | —                 | -100 | —                                | —                 | -100 | —                                | —                 | -100 | dBc/Hz      |
|  | 100 kHz  | —                                | —                 | -110 | —                                | —                 | -110 | —                                | —                 | -110 | dBc/Hz      |
|  | $\geq 1$ MHz   | —                                | —                 | -120 | —                                | —                 | -120 | —                                | —                 | -120 | dBc/Hz      |
| Transmitter<br>REFCLK Phase<br>Jitter<br>(100 MHz) <sup>(17)</sup> | 10 kHz to<br>1.5 MHz<br>(PCIe)                         | —                                | —                 | 3    | —                                | —                 | 3    | —                                | —                 | 3    | ps<br>(rms) |
| $R_{REF}$ <sup>(19)</sup>  | —  | —                                | 1800<br>$\pm 1\%$ | —    | —                                | 1800<br>$\pm 1\%$ | —    | —                                | 1800<br>$\pm 1\%$ | —    | $\Omega$    |
| <b>Transceiver Clocks</b>  |  |                                  |                   |      |                                  |                   |      |                                  |                   |      |             |
| fixedclk clock<br>frequency  | PCIe<br>Receiver<br>Detect                             | —                                | 100<br>or<br>125  | —    | —                                | 100<br>or<br>125  | —    | —                                | 100<br>or<br>125  | —    | MHz         |

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 5 of 7)**

| Symbol/<br>Description  | Conditions   | Transceiver Speed<br>Grade 1 |                     |       | Transceiver Speed<br>Grade 2 |                     |       | Transceiver Speed<br>Grade 3 |                     |                                     | Unit     |
|---|--|------------------------------|---------------------|-------|------------------------------|---------------------|-------|------------------------------|---------------------|-------------------------------------|----------|
|   |  | Min                          | Typ                 | Max   | Min                          | Typ                 | Max   | Min                          | Typ                 | Max                                 |          |
| Programmable<br>DC gain   | DC Gain<br>Setting = 0                                     | —                            | 0                   | —     | —                            | 0                   | —     | —                            | 0                   | —                                   | dB       |
|   | DC Gain<br>Setting = 1                                     | —                            | 2                   | —     | —                            | 2                   | —     | —                            | 2                   | —                                   | dB       |
|   | DC Gain<br>Setting = 2                                     | —                            | 4                   | —     | —                            | 4                   | —     | —                            | 4                   | —                                   | dB       |
|   | DC Gain<br>Setting = 3                                     | —                            | 6                   | —     | —                            | 6                   | —     | —                            | 6                   | —                                   | dB       |
|   | DC Gain<br>Setting = 4                                     | —                            | 8                   | —     | —                            | 8                   | —     | —                            | 8                   | —                                   | dB       |
| <b>Transmitter</b>  |  |                              |                     |       |                              |                     |       |                              |                     |                                     |          |
| Supported I/O<br>Standards  | —  | 1.4-V and 1.5-V PCML         |                     |       |                              |                     |       |                              |                     |                                     |          |
| Data rate<br>(Standard PCS)   | —  | 600                          | —                   | 12200 | 600                          | —                   | 12200 | 600                          | —                   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps     |
| Data rate<br>(10G PCS)  | —  | 600                          | —                   | 14100 | 600                          | —                   | 12500 | 600                          | —                   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps     |
| Differential on-<br>chip termination<br>resistors                     | 85- $\Omega$<br>setting                                    | —                            | 85 $\pm$<br>20%     | —     | —                            | 85 $\pm$<br>20%     | —     | —                            | 85 $\pm$<br>20%     | —                                   | $\Omega$ |
|   | 100- $\Omega$<br>setting                                   | —                            | 100<br>$\pm$<br>20% | —     | —                            | 100<br>$\pm$<br>20% | —     | —                            | 100<br>$\pm$<br>20% | —                                   | $\Omega$ |
|   | 120- $\Omega$<br>setting                                   | —                            | 120<br>$\pm$<br>20% | —     | —                            | 120<br>$\pm$<br>20% | —     | —                            | 120<br>$\pm$<br>20% | —                                   | $\Omega$ |
|   | 150- $\Omega$<br>setting                                   | —                            | 150<br>$\pm$<br>20% | —     | —                            | 150<br>$\pm$<br>20% | —     | —                            | 150<br>$\pm$<br>20% | —                                   | $\Omega$ |
| V <sub>OCM</sub> (AC<br>coupled)                                      | 0.65-V<br>setting  | —                            | 650                 | —     | —                            | 650                 | —     | —                            | 650                 | —                                   | mV       |
| V <sub>OCM</sub> (DC<br>coupled)                                      | —  | —                            | 650                 | —     | —                            | 650                 | —     | —                            | 650                 | —                                   | mV       |
| Rise time <sup>(7)</sup>  | 20% to 80%   | 30                           | —                   | 160   | 30                           | —                   | 160   | 30                           | —                   | 160                                 | ps       |
| Fall time <sup>(7)</sup>  | 80% to 20%   | 30                           | —                   | 160   | 30                           | —                   | 160   | 30                           | —                   | 160                                 | ps       |
| Intra-differential<br>pair skew                                       | Tx V <sub>CM</sub> =<br>0.5 V and<br>slew rate of<br>15 ps | —                            | —                   | 15    | —                            | —                   | 15    | —                            | —                   | 15                                  | ps       |
| Intra-transceiver<br>block transmitter<br>channel-to-<br>channel skew | x6 PMA<br>bonded mode                                      | —                            | —                   | 120   | —                            | —                   | 120   | —                            | —                   | 120                                 | ps       |



**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 1 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions   | Transceiver<br>Speed Grade 2   |           |      | Transceiver<br>Speed Grade 3 |           |      | Unit |
|--|--|--|-----------|------|------------------------------|-----------|------|------|
|  |  | Min  | Typ       | Max  | Min                          | Typ       | Max  |      |
| Reference Clock  |  |  |           |      |                              |           |      |      |
| Supported I/O<br>Standards                                     | Dedicated<br>reference<br>clock pin                    | 1.2-V PCML, 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, Differential LVPECL, LVDS,<br>and HCSL |           |      |                              |           |      |      |
|  | RX reference<br>clock pin                              | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS                                   |           |      |                              |           |      |      |
| Input Reference Clock<br>Frequency (CMU<br>PLL) <sup>(6)</sup> | —  | 40   | —         | 710  | 40                           | —         | 710  | MHz  |
| Input Reference Clock<br>Frequency (ATX PLL) <sup>(6)</sup>    | —  | 100  | —         | 710  | 100                          | —         | 710  | MHz  |
| Rise time  | 20% to 80%   | —  | —         | 400  | —                            | —         | 400  | ps   |
| Fall time  | 80% to 20%   | —  | —         | 400  | —                            | —         | 400  |      |
| Duty cycle   | —  | 45   | —         | 55   | 45                           | —         | 55   | %    |
| Spread-spectrum<br>modulating clock<br>frequency               | PCI Express<br>(PCIe)                                  | 30   | —         | 33   | 30                           | —         | 33   | kHz  |
| Spread-spectrum<br>downspread                                  | PCIe   | —  | 0 to −0.5 | —    | —                            | 0 to −0.5 | —    | %    |
| On-chip termination<br>resistors <sup>(19)</sup>               | —  | —  | 100       | —    | —                            | 100       | —    | Ω    |
| Absolute V <sub>MAX</sub> <sup>(3)</sup>                       | Dedicated<br>reference<br>clock pin                    | —  | —         | 1.6  | —                            | —         | 1.6  | V    |
|  | RX reference<br>clock pin                              | —  | —         | 1.2  | —                            | —         | 1.2  |      |
| Absolute V <sub>MIN</sub>                                      | —  | -0.4   | —         | —    | -0.4                         | —         | —    | V    |
| Peak-to-peak<br>differential input<br>voltage                  | —  | 200  | —         | 1600 | 200                          | —         | 1600 | mV   |
| V <sub>ICM</sub> (AC coupled)                                  | Dedicated<br>reference<br>clock pin                    | 1050/1000 <sup>(2)</sup>   |           |      | 1050/1000 <sup>(2)</sup>     |           |      | mV   |
|  | RX reference<br>clock pin                              | 1.0/0.9/0.85 <sup>(22)</sup>   |           |      | 1.0/0.9/0.85 <sup>(22)</sup> |           |      | V    |
| V <sub>ICM</sub> (DC coupled)                                  | HCSL I/O<br>standard for<br>PCIe<br>reference<br>clock | 250  | —         | 550  | 250                          | —         | 550  | mV   |

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 3 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions                      | Transceiver<br>Speed Grade 2 |               |        | Transceiver<br>Speed Grade 3 |               |        | Unit      |
|--|---------------------------------|------------------------------|---------------|--------|------------------------------|---------------|--------|-----------|
|  |                                 | Min                          | Typ           | Max    | Min                          | Typ           | Max    |           |
| Differential on-chip termination resistors <sup>(7)</sup>                  | GT channels                     | —                            | 100           | —      | —                            | 100           | —      | $\Omega$  |
| Differential on-chip termination resistors for GX channels <sup>(19)</sup> | 85- $\Omega$ setting            | —                            | 85 $\pm$ 30%  | —      | —                            | 85 $\pm$ 30%  | —      | $\Omega$  |
|  | 100- $\Omega$ setting           | —                            | 100 $\pm$ 30% | —      | —                            | 100 $\pm$ 30% | —      | $\Omega$  |
|  | 120- $\Omega$ setting           | —                            | 120 $\pm$ 30% | —      | —                            | 120 $\pm$ 30% | —      | $\Omega$  |
|  | 150- $\Omega$ setting           | —                            | 150 $\pm$ 30% | —      | —                            | 150 $\pm$ 30% | —      | $\Omega$  |
| V <sub>ICM</sub> (AC coupled)  | GT channels                     | —                            | 650           | —      | —                            | 650           | —      | mV        |
| VICM (AC and DC coupled) for GX Channels                                   | VCCR_GXB = 0.85 V or 0.9 V      | —                            | 600           | —      | —                            | 600           | —      | mV        |
|  | VCCR_GXB = 1.0 V full bandwidth | —                            | 700           | —      | —                            | 700           | —      | mV        |
|  | VCCR_GXB = 1.0 V half bandwidth | —                            | 750           | —      | —                            | 750           | —      | mV        |
| t <sub>LTR</sub> <sup>(9)</sup>  | —                               | —                            | —             | 10     | —                            | —             | 10     | $\mu$ s   |
| t <sub>LTD</sub> <sup>(10)</sup>   | —                               | 4                            | —             | —      | 4                            | —             | —      | $\mu$ s   |
| t <sub>LTD_manual</sub> <sup>(11)</sup>                                    | —                               | 4                            | —             | —      | 4                            | —             | —      | $\mu$ s   |
| t <sub>LTR_LTD_manual</sub> <sup>(12)</sup>                                | —                               | 15                           | —             | —      | 15                           | —             | —      | $\mu$ s   |
| Run Length   | GT channels                     | —                            | —             | 72     | —                            | —             | 72     | CID       |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| CDR PPM  | GT channels                     | —                            | —             | 1000   | —                            | —             | 1000   | $\pm$ PPM |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Programmable equalization (AC Gain) <sup>(5)</sup>                         | GT channels                     | —                            | —             | 14     | —                            | —             | 14     | dB        |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Programmable DC gain <sup>(6)</sup>  | GT channels                     | —                            | —             | 7.5    | —                            | —             | 7.5    | dB        |
|  | GX channels                     | <sup>(8)</sup>               |               |        |                              |               |        |           |
| Differential on-chip termination resistors <sup>(7)</sup>                  | GT channels                     | —                            | 100           | —      | —                            | 100           | —      | $\Omega$  |
| <b>Transmitter</b>   |                                 |                              |               |        |                              |               |        |           |
| Supported I/O Standards  | —                               | 1.4-V and 1.5-V PCML         |               |        |                              |               |        |           |
| Data rate (Standard PCS)   | GX channels                     | 600                          | —             | 8500   | 600                          | —             | 8500   | Mbps      |
| Data rate (10G PCS)  | GX channels                     | 600                          | —             | 12,500 | 600                          | —             | 12,500 | Mbps      |

**Table 28. Transceiver Specifications for Stratix V GT Devices (Part 4 of 5) <sup>(1)</sup>**

| Symbol/<br>Description   | Conditions                                   | Transceiver<br>Speed Grade 2 |     |                                | Transceiver<br>Speed Grade 3 |     |                                | Unit |
|--|--|------------------------------|-----|--------------------------------|------------------------------|-----|--------------------------------|------|
|  |  | Min                          | Typ | Max                            | Min                          | Typ | Max                            |      |
| Data rate  | GT channels                                  | 19,600                       | —   | 28,050                         | 19,600                       | —   | 25,780                         | Mbps |
| Differential on-chip<br>termination resistors                      | GT channels                                  | —                            | 100 | —                              | —                            | 100 | —                              | Ω    |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| V <sub>OCM</sub> (AC coupled)                                      | GT channels                                  | —                            | 500 | —                              | —                            | 500 | —                              | mV   |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Rise/Fall time   | GT channels                                  | —                            | 15  | —                              | —                            | 15  | —                              | ps   |
|  | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Intra-differential pair<br>skew                                    | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Intra-transceiver block<br>transmitter channel-to-<br>channel skew | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| Inter-transceiver block<br>transmitter channel-to-<br>channel skew | GX channels                                  | (8)                          |     |                                |                              |     |                                |      |
| CMU PLL  |  |                              |     |                                |                              |     |                                |      |
| Supported Data Range   | —  | 600                          | —   | 12500                          | 600                          | —   | 8500                           | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |
| t <sub>pll_lock</sub> <sup>(14)</sup>                              | —  | —                            | —   | 10                             | —                            | —   | 10                             | μs   |
| ATX PLL  |  |                              |     |                                |                              |     |                                |      |
| Supported Data Rate<br>Range for GX Channels                       | VCO post-<br>divider L=2                     | 8000                         | —   | 12500                          | 8000                         | —   | 8500                           | Mbps |
|  | L=4  | 4000                         | —   | 6600                           | 4000                         | —   | 6600                           | Mbps |
|  | L=8  | 2000                         | —   | 3300                           | 2000                         | —   | 3300                           | Mbps |
|  | L=8,<br>Local/Central<br>Clock Divider<br>=2 | 1000                         | —   | 1762.5                         | 1000                         | —   | 1762.5                         | Mbps |
| Supported Data Rate<br>Range for GT Channels                       | VCO post-<br>divider L=2                     | 9800                         | —   | 14025                          | 9800                         | —   | 12890                          | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |
| t <sub>pll_lock</sub> <sup>(14)</sup>                              | —  | —                            | —   | 10                             | —                            | —   | 10                             | μs   |
| fPLL   |  |                              |     |                                |                              |     |                                |      |
| Supported Data Range   | —  | 600                          | —   | 3250/<br>3.125 <sup>(23)</sup> | 600                          | —   | 3250/<br>3.125 <sup>(23)</sup> | Mbps |
| t <sub>pll_powerdown</sub> <sup>(13)</sup>                         | —  | 1                            | —   | —                              | 1                            | —   | —                              | μs   |

## Periphery Performance

This section describes periphery performance, including high-speed I/O and external memory interface.

I/O performance supports several system interfaces, such as the **LVDS** high-speed I/O interface, external memory interface, and the **PCI/PCI-X** bus interface.

General-purpose I/O standards such as 3.3-, 2.5-, 1.8-, and 1.5-**LVTTL/LVCMOS** are capable of a typical 167 MHz and 1.2-**LVCMOS** at 100 MHz interfacing frequency with a 10 pF load.



The actual achievable frequency depends on design- and system-specific factors. Ensure proper timing closure in your design and perform HSPICE/IBIS simulations based on your specific design and system setup to determine the maximum achievable frequency in your system.

### High-Speed I/O Specification

Table 36 lists high-speed I/O timing for Stratix V devices.

**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1)</sup>, <sup>(2)</sup> (Part 1 of 4)**

| Symbol   | Conditions   | C1  |     |     | C2, C2L, I2, I2L |     |     | C3, I3, I3L, I3YY |     |                    | C4,I4 |     |                    | Unit |
|--|--|-----|-----|-----|------------------|-----|-----|-------------------|-----|--------------------|-------|-----|--------------------|------|
|  |  | Min | Typ | Max | Min              | Typ | Max | Min               | Typ | Max                | Min   | Typ | Max                |      |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>True Differential I/O Standards           | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625                | 5     | —   | 525                | MHz  |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>Single Ended I/O Standards <sup>(3)</sup> | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625                | 5     | —   | 525                | MHz  |
| $f_{\text{HCLK\_in}}$ (input clock frequency)<br>Single Ended I/O Standards                | Clock boost factor<br>$W = 1$ to 40 <sup>(4)</sup> | 5   | —   | 520 | 5                | —   | 520 | 5                 | —   | 420                | 5     | —   | 420                | MHz  |
| $f_{\text{HCLK\_OUT}}$ (output clock frequency)  | —  | 5   | —   | 800 | 5                | —   | 800 | 5                 | —   | 625 <sup>(5)</sup> | 5     | —   | 525 <sup>(5)</sup> | MHz  |

**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1), (2)</sup> (Part 4 of 4)**

| Symbol                        | Conditions                              | C1  |     |           | C2, C2L, I2, I2L |     |           | C3, I3, I3L, I3YY |     |           | C4, I4 |     |           | Unit  |
|-------------------------------|---|-----|-----|-----------|------------------|-----|-----------|-------------------|-----|-----------|--------|-----|-----------|-------|
|                               |   | Min | Typ | Max       | Min              | Typ | Max       | Min               | Typ | Max       | Min    | Typ | Max       |       |
| f <sub>HSDR</sub> (data rate) | SERDES factor J = 3 to 10               | (6) | —   | (8)       | (6)              | —   | (8)       | (6)               | —   | (8)       | (6)    | —   | (8)       | Mbps  |
|                               | SERDES factor J = 2, uses DDR Registers | (6) | —   | (7)       | (6)              | —   | (7)       | (6)               | —   | (7)       | (6)    | —   | (7)       | Mbps  |
|                               | SERDES factor J = 1, uses SDR Register  | (6) | —   | (7)       | (6)              | —   | (7)       | (6)               | —   | (7)       | (6)    | —   | (7)       | Mbps  |
| <b>DPA Mode</b>               |   |     |     |           |                  |     |           |                   |     |           |        |     |           |       |
| DPA run length                | —                                       | —   | —   | 1000<br>0 | —                | —   | 1000<br>0 | —                 | —   | 1000<br>0 | —      | —   | 1000<br>0 | UI    |
| <b>Soft CDR mode</b>          |   |     |     |           |                  |     |           |                   |     |           |        |     |           |       |
| Soft-CDR PPM tolerance        | —                                       | —   | —   | 300       | —                | —   | 300       | —                 | —   | 300       | —      | —   | 300       | ± PPM |
| <b>Non DPA Mode</b>           |   |     |     |           |                  |     |           |                   |     |           |        |     |           |       |
| Sampling Window               | —                                       | —   | —   | 300       | —                | —   | 300       | —                 | —   | 300       | —      | —   | 300       | ps    |

**Notes to Table 36:**

- (1) When J = 3 to 10, use the serializer/deserializer (SERDES) block.
- (2) When J = 1 or 2, bypass the SERDES block.
- (3) This only applies to DPA and soft-CDR modes.
- (4) Clock Boost Factor (W) is the ratio between the input data rate to the input clock rate.
- (5) This is achieved by using the **LVDS** clock network.
- (6) The minimum specification depends on the clock source (for example, the PLL and clock pin) and the clock routing resource (global, regional, or local) that you use. The I/O differential buffer and input register do not have a minimum toggle rate.
- (7) The maximum ideal frequency is the SERDES factor (J) x the PLL maximum output frequency (f<sub>OUT</sub>) provided you can close the design timing and the signal integrity simulation is clean.
- (8) You can estimate the achievable maximum data rate for non-DPA mode by performing link timing closure analysis. You must consider the board skew margin, transmitter delay margin, and receiver sampling margin to determine the maximum data rate supported.
- (9) If the receiver with DPA enabled and transmitter are using shared PLLs, the minimum data rate is 150 Mbps.
- (10) You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and receiver sampling margin to determine leftover timing margin.
- (11) The F<sub>MAX</sub> specification is based on the fast clock used for serial data. The interface F<sub>MAX</sub> is also dependent on the parallel clock domain which is design-dependent and requires timing analysis.
- (12) Stratix V RX LVDS will need DPA. For Stratix V TX LVDS, the receiver side component must have DPA.
- (13) Stratix V LVDS serialization and de-serialization factor needs to be x4 and above.
- (14) Requires package skew compensation with PCB trace length.
- (15) Do not mix single-ended I/O buffer within LVDS I/O bank.
- (16) Chip-to-chip communication only with a maximum load of 5 pF.
- (17) When using True LVDS RX channels for emulated LVDS TX channel, only serialization factors 1 and 2 are supported.

**Table 40. DQS Phase Offset Delay Per Setting for Stratix V Devices <sup>(1), (2)</sup> (Part 2 of 2)**

| Speed Grade | Min | Max | Unit |
|-------------|-----|-----|------|
| C4,I4       | 8   | 16  | ps   |

**Notes to Table 40:**

- (1) The typical value equals the average of the minimum and maximum values.
- (2) The delay settings are linear with a cumulative delay variation of 40 ps for all speed grades. For example, when using a –2 speed grade and applying a 10-phase offset setting to a 90° phase shift at 400 MHz, the expected average cumulative delay is  $[625 \text{ ps} + (10 \times 10 \text{ ps}) \pm 20 \text{ ps}] = 725 \text{ ps} \pm 20 \text{ ps}$ .

Table 41 lists the DQS phase shift error for Stratix V devices.

**Table 41. DQS Phase Shift Error Specification for DLL-Delayed Clock ( $t_{\text{DQS\_PSERR}}$ ) for Stratix V Devices <sup>(1)</sup>**

| Number of DQS Delay Buffers | C1  | C2, C2L, I2, I2L | C3, I3, I3L, I3YY | C4,I4 | Unit |
|-----------------------------|-----|------------------|-------------------|-------|------|
| 1                           | 28  | 28               | 30                | 32    | ps   |
| 2                           | 56  | 56               | 60                | 64    | ps   |
| 3                           | 84  | 84               | 90                | 96    | ps   |
| 4                           | 112 | 112              | 120               | 128   | ps   |

**Notes to Table 41:**

- (1) This error specification is the absolute maximum and minimum error. For example, skew on three DQS delay buffers in a –2 speed grade is  $\pm 78 \text{ ps}$  or  $\pm 39 \text{ ps}$ .

Table 42 lists the memory output clock jitter specifications for Stratix V devices.

**Table 42. Memory Output Clock Jitter Specification for Stratix V Devices <sup>(1), (Part 1 of 2)</sup> <sup>(2), (3)</sup>**

| Clock Network | Parameter                    | Symbol                 | C1   |     | C2, C2L, I2, I2L |     | C3, I3, I3L, I3YY |      | C4,I4 |      | Unit |
|---------------|------------------------------|------------------------|------|-----|------------------|-----|-------------------|------|-------|------|------|
|               |                              |                        | Min  | Max | Min              | Max | Min               | Max  | Min   | Max  |      |
| Regional      | Clock period jitter          | $t_{\text{JIT(per)}}$  | –50  | 50  | –50              | 50  | –55               | 55   | –55   | 55   | ps   |
|               | Cycle-to-cycle period jitter | $t_{\text{JIT(cc)}}$   | –100 | 100 | –100             | 100 | –110              | 110  | –110  | 110  | ps   |
|               | Duty cycle jitter            | $t_{\text{JIT(duty)}}$ | –50  | 50  | –50              | 50  | –82.5             | 82.5 | –82.5 | 82.5 | ps   |
| Global        | Clock period jitter          | $t_{\text{JIT(per)}}$  | –75  | 75  | –75              | 75  | –82.5             | 82.5 | –82.5 | 82.5 | ps   |
|               | Cycle-to-cycle period jitter | $t_{\text{JIT(cc)}}$   | –150 | 150 | –150             | 150 | –165              | 165  | –165  | 165  | ps   |
|               | Duty cycle jitter            | $t_{\text{JIT(duty)}}$ | –75  | 75  | –75              | 75  | –90               | 90   | –90   | 90   | ps   |

**Table 49. DCLK-to-DATA[] Ratio <sup>(1)</sup> (Part 2 of 2)**

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|----------------------|---------------|-----------------|----------------------|
| FPP ×32              | Disabled      | Disabled        | 1                    |
|                      | Disabled      | Enabled         | 4                    |
|                      | Enabled       | Disabled        | 8                    |
|                      | Enabled       | Enabled         | 8                    |

**Note to Table 49:**

- (1) Depending on the DCLK-to-DATA[] ratio, the host must send a DCLK frequency that is r times the data rate in bytes per second (Bps), or words per second (Wps). For example, in FPP ×16 when the DCLK-to-DATA[] ratio is 2, the DCLK frequency must be 2 times the data rate in Wps. Stratix V devices use the additional clock cycles to decrypt and decompress the configuration data.



If the DCLK-to-DATA[] ratio is greater than 1, at the end of configuration, you can only stop the DCLK (DCLK-to-DATA[] ratio – 1) clock cycles after the last data is latched into the Stratix V device.

Figure 11 shows the configuration interface connections between the Stratix V device and a MAX II or MAX V device for single device configuration.

**Figure 11. Single Device FPP Configuration Using an External Host****Notes to Figure 11:**

- (1) Connect the resistor to a supply that provides an acceptable input signal for the Stratix V device.  $V_{CCPGM}$  must be high enough to meet the  $V_{IH}$  specification of the I/O on the device and the external host. Altera recommends powering up all configuration system I/Os with  $V_{CCPGM}$ .
- (2) You can leave the nCEO pin unconnected or use it as a user I/O pin when it does not feed another device's nCE pin.
- (3) The MSEL pin settings vary for different data width, configuration voltage standards, and POR delay. To connect MSEL, refer to the MSEL Pin Settings section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (4) If you use FPP ×8, use DATA[7..0]. If you use FPP ×16, use DATA[15..0].

Table 50 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [] ratio is 1.

**Table 50. FPP Timing Parameters for Stratix V Devices <sup>(1)</sup>**

| Symbol                            | Parameter   | Minimum  | Maximum              | Units |
|-----------------------------------|---|--|----------------------|-------|
| t <sub>CF2CD</sub>                | nCONFIG low to CONF_DONE low                      | —  | 600                  | ns    |
| t <sub>CF2ST0</sub>               | nCONFIG low to nSTATUS low                        | —  | 600                  | ns    |
| t <sub>CFG</sub>                  | nCONFIG low pulse width                           | 2  | —                    | μs    |
| t <sub>STATUS</sub>               | nSTATUS low pulse width                           | 268  | 1,506 <sup>(2)</sup> | μs    |
| t <sub>CF2ST1</sub>               | nCONFIG high to nSTATUS high                      | —  | 1,506 <sup>(3)</sup> | μs    |
| t <sub>CF2CK</sub> <sup>(6)</sup> | nCONFIG high to first rising edge on DCLK         | 1,506  | —                    | μs    |
| t <sub>ST2CK</sub> <sup>(6)</sup> | nSTATUS high to first rising edge of DCLK         | 2  | —                    | μs    |
| t <sub>DSU</sub>                  | DATA [] setup time before rising edge on DCLK     | 5.5  | —                    | ns    |
| t <sub>DH</sub>                   | DATA [] hold time after rising edge on DCLK       | 0  | —                    | ns    |
| t <sub>CH</sub>                   | DCLK high time                                    | $0.45 \times 1/f_{\text{MAX}}$                             | —                    | s     |
| t <sub>CL</sub>                   | DCLK low time                                     | $0.45 \times 1/f_{\text{MAX}}$                             | —                    | s     |
| t <sub>CLK</sub>                  | DCLK period                                       | $1/f_{\text{MAX}}$   | —                    | s     |
| f <sub>MAX</sub>                  | DCLK frequency (FPP $\times 8/\times 16$ )        | —  | 125                  | MHz   |
|                                   | DCLK frequency (FPP $\times 32$ )                 | —  | 100                  | MHz   |
| t <sub>CD2UM</sub>                | CONF_DONE high to user mode <sup>(4)</sup>        | 175  | 437                  | μs    |
| t <sub>CD2CU</sub>                | CONF_DONE high to CLKUSR enabled                  | 4 × maximum DCLK period                                    | —                    | —     |
| t <sub>CD2UMC</sub>               | CONF_DONE high to user mode with CLKUSR option on | t <sub>CD2CU</sub> + (8576 × CLKUSR period) <sup>(5)</sup> | —                    | —     |

**Notes to Table 50:**

- (1) Use these timing parameters when the decompression and design security features are disabled.
- (2) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.
- (4) The minimum and maximum numbers apply only if you chose the internal oscillator as the clock source for initializing the device.
- (5) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (6) If nSTATUS is monitored, follow the t<sub>ST2CK</sub> specification. If nSTATUS is not monitored, follow the t<sub>CF2CK</sub> specification.

### FPP Configuration Timing when DCLK-to-DATA [] > 1

Figure 13 shows the timing waveform for FPP configuration when using a MAX II device, MAX V device, or microprocessor as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is more than 1.



Table 54 lists the PS configuration timing parameters for Stratix V devices.

**Table 54. PS Timing Parameters for Stratix V Devices**

| Symbol                     | Parameter   | Minimum   | Maximum              | Units   |
|----------------------------|---|---|----------------------|---------|
| $t_{CF2CD}$                | nCONFIG low to CONF_DONE low                      | —   | 600                  | ns      |
| $t_{CF2ST0}$               | nCONFIG low to nSTATUS low                        | —   | 600                  | ns      |
| $t_{CFG}$                  | nCONFIG low pulse width                           | 2   | —                    | $\mu$ s |
| $t_{STATUS}$               | nSTATUS low pulse width                           | 268   | 1,506 <sup>(1)</sup> | $\mu$ s |
| $t_{CF2ST1}$               | nCONFIG high to nSTATUS high                      | —   | 1,506 <sup>(2)</sup> | $\mu$ s |
| $t_{CF2CK}$ <sup>(5)</sup> | nCONFIG high to first rising edge on DCLK         | 1,506   | —                    | $\mu$ s |
| $t_{ST2CK}$ <sup>(5)</sup> | nSTATUS high to first rising edge of DCLK         | 2   | —                    | $\mu$ s |
| $t_{DSU}$                  | DATA [] setup time before rising edge on DCLK     | 5.5   | —                    | ns      |
| $t_{DH}$                   | DATA [] hold time after rising edge on DCLK       | 0   | —                    | ns      |
| $t_{CH}$                   | DCLK high time                                    | $0.45 \times 1/f_{MAX}$   | —                    | s       |
| $t_{CL}$                   | DCLK low time                                     | $0.45 \times 1/f_{MAX}$   | —                    | s       |
| $t_{CLK}$                  | DCLK period                                       | $1/f_{MAX}$   | —                    | s       |
| $f_{MAX}$                  | DCLK frequency                                    | —   | 125                  | MHz     |
| $t_{CD2UM}$                | CONF_DONE high to user mode <sup>(3)</sup>        | 175   | 437                  | $\mu$ s |
| $t_{CD2CU}$                | CONF_DONE high to CLKUSR enabled                  | 4 × maximum DCLK period   | —                    | —       |
| $t_{CD2UMC}$               | CONF_DONE high to user mode with CLKUSR option on | $t_{CD2CU} + (8576 \times \text{CLKUSR period})$ <sup>(4)</sup> | —                    | —       |

**Notes to Table 54:**

- (1) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (2) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.
- (3) The minimum and maximum numbers apply only if you choose the internal oscillator as the clock source for initializing the device.
- (4) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the “Initialization” section.
- (5) If nSTATUS is monitored, follow the  $t_{ST2CK}$  specification. If nSTATUS is not monitored, follow the  $t_{CF2CK}$  specification.

## Initialization

Table 55 lists the initialization clock source option, the applicable configuration schemes, and the maximum frequency.

**Table 55. Initialization Clock Source Option and the Maximum Frequency**

| Initialization Clock Source | Configuration Schemes      | Maximum Frequency | Minimum Number of Clock Cycles <sup>(1)</sup> |
|-----------------------------|----------------------------|-------------------|---|
| Internal Oscillator         | AS, PS, FPP                | 12.5 MHz          | 8576  |
| CLKUSR                      | AS, PS, FPP <sup>(2)</sup> | 125 MHz           |   |
| DCLK                        | PS, FPP                    | 125 MHz           |   |

**Notes to Table 55:**

- (1) The minimum number of clock cycles required for device initialization.
- (2) To enable CLKUSR as the initialization clock source, turn on the **Enable user-supplied start-up clock (CLKUSR)** option in the Quartus II software from the **General** panel of the **Device and Pin Options** dialog box.

**Table 58. IOE Programmable Delay for Stratix V Devices (Part 2 of 2)**

| Parameter<br>(1) | Available<br>Settings | Min<br>Offset<br>(2) | Fast Model |            | Slow Model |       |       |       |       |             |       |      |
|------------------|-----------------------|----------------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|------|
|                  |                       |                      | Industrial | Commercial | C1         | C2    | C3    | C4    | I2    | I3,<br>I3YY | I4    | Unit |
| D3               | 8                     | 0                    | 1.587      | 1.699      | 2.793      | 2.793 | 2.992 | 3.192 | 2.811 | 3.047       | 3.257 | ns   |
| D4               | 64                    | 0                    | 0.464      | 0.492      | 0.838      | 0.838 | 0.924 | 1.011 | 0.843 | 0.920       | 1.006 | ns   |
| D5               | 64                    | 0                    | 0.464      | 0.493      | 0.838      | 0.838 | 0.924 | 1.011 | 0.844 | 0.921       | 1.006 | ns   |
| D6               | 32                    | 0                    | 0.229      | 0.244      | 0.415      | 0.415 | 0.458 | 0.503 | 0.418 | 0.456       | 0.499 | ns   |

**Notes to Table 58:**

- (1) You can set this value in the Quartus II software by selecting **D1**, **D2**, **D3**, **D5**, and **D6** in the **Assignment Name** column of **Assignment Editor**.
- (2) Minimum offset does not include the intrinsic delay.

## Programmable Output Buffer Delay

Table 59 lists the delay chain settings that control the rising and falling edge delays of the output buffer. The default delay is 0 ps.

**Table 59. Programmable Output Buffer Delay for Stratix V Devices (1)**

| Symbol              | Parameter                        | Typical     | Unit |
|---------------------|----------------------------------|-------------|------|
| D <sub>OUTBUF</sub> | Rising and/or falling edge delay | 0 (default) | ps   |
|                     |                                  | 25          | ps   |
|                     |                                  | 50          | ps   |
|                     |                                  | 75          | ps   |

**Note to Table 59:**

- (1) You can set the programmable output buffer delay in the Quartus II software by setting the **Output Buffer Delay Control** assignment to either positive, negative, or both edges, with the specific values stated here (in ps) for the **Output Buffer Delay** assignment.

## Glossary

Table 60 lists the glossary for this chapter.

**Table 60. Glossary (Part 1 of 4)**

| Letter   | Subject              | Definitions   |
|----------|----------------------|---|
| <b>A</b> | —                    | —   |
| <b>B</b> |                      |   |
| <b>C</b> |                      |   |
| <b>D</b> | —                    | —   |
| <b>E</b> | —                    | —   |
| <b>F</b> | f <sub>HCLK</sub>    | Left and right PLL input clock frequency.   |
|          | f <sub>HSDR</sub>    | High-speed I/O block—Maximum and minimum <b>LVDS</b> data transfer rate (f <sub>HSDR</sub> = 1/TUI), non-DPA. |
|          | f <sub>HSDRDPA</sub> | High-speed I/O block—Maximum and minimum <b>LVDS</b> data transfer rate (f <sub>HSDRDPA</sub> = 1/TUI), DPA.  |

Table 60. Glossary (Part 3 of 4)

| Letter | Subject                                      | Definitions  |
|--------|--|--|
| S      | SW (sampling window)                         | <p>Timing Diagram—the period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position within the sampling window, as shown:</p>    |
|        | Single-ended voltage referenced I/O standard | <p>The JEDEC standard for <b>SSTL</b> and <b>HSTL</b> I/O defines both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input has crossed the AC value, the receiver changes to the new logic state.</p> <p>The new logic state is then maintained as long as the input stays beyond the DC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing:</p> <p><i>Single-Ended Voltage Referenced I/O Standard</i></p>  |
| T      | $t_c$  | High-speed receiver and transmitter input and output clock period.   |
|        | TCCS (channel-to-channel-skew)               | The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement (refer to the <i>Timing Diagram</i> figure under <b>SW</b> in this table).  |
|        | $t_{DUTY}$                                   | <p>High-speed I/O block—Duty cycle on the high-speed transmitter output clock.</p> <p><b>Timing Unit Interval (TUI)</b></p> <p>The timing budget allowed for skew, propagation delays, and the data sampling window. (TUI = <math>1/(\text{receiver input clock frequency multiplication factor}) = t_c/w</math>)</p>  |
|        | $t_{FALL}$                                   | Signal high-to-low transition time (80-20%)  |
|        | $t_{INCCJ}$                                  | Cycle-to-cycle jitter tolerance on the PLL clock input.  |
|        | $t_{OUTPJ\_IO}$                              | Period jitter on the general purpose I/O driven by a PLL.  |
|        | $t_{OUTPJ\_DC}$                              | Period jitter on the dedicated clock output driven by a PLL.   |
|        | $t_{RISE}$                                   | Signal low-to-high transition time (20-80%)  |
| U      | —  | —  |

## Document Revision History

Table 61 lists the revision history for this chapter.

**Table 61. Document Revision History (Part 1 of 3)**

| Date          | Version | Changes   |
|---------------|---------|---|
| June 2018     | 3.9     | <ul style="list-style-type: none"> <li>■ Added the “Stratix V Device Overshoot Duration” figure.</li> </ul>   |
| April 2017    | 3.8     | <ul style="list-style-type: none"> <li>■ Added a footnote to the “High-Speed I/O Specifications for Stratix V Devices” table.</li> <li>■ Changed the minimum value for <math>t_{CD2UMC}</math> in the “PS Timing Parameters for Stratix V Devices” table.</li> <li>■ Changed the condition for <math>100\text{-}\Omega</math> <math>R_D</math> in the “OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices” table.</li> <li>■ Changed the minimum value for <math>t_{CD2UMC}</math> in the “AS Timing Parameters for AS ‘1 and AS ‘4 Configurations in Stratix V Devices” table</li> <li>■ Changed the minimum value for <math>t_{CD2UMC}</math> in the “FPP Timing Parameters for Stratix V Devices When the DCLK-to-DATA[] Ratio is &gt;1” table.</li> <li>■ Changed the minimum value for <math>t_{CD2UMC}</math> in the “FPP Timing Parameters for Stratix V Devices When the DCLK-to-DATA[] Ratio is &gt;1” table.</li> <li>■ Changed the minimum number of clock cycles value in the “Initialization Clock Source Option and the Maximum Frequency” table.</li> </ul> |
| June 2016     | 3.7     | <ul style="list-style-type: none"> <li>■ Added the <math>V_{ID}</math> minimum specification for LVPECL in the “Differential I/O Standard Specifications for Stratix V Devices” table</li> <li>■ Added the <math>I_{OUT}</math> specification to the “Absolute Maximum Ratings for Stratix V Devices” table.</li> </ul>   |
| December 2015 | 3.6     | <ul style="list-style-type: none"> <li>■ Added a footnote to the “High-Speed I/O Specifications for Stratix V Devices” table.</li> </ul>  |
| December 2015 | 3.5     | <ul style="list-style-type: none"> <li>■ Changed the transmitter, receiver, and ATX PLL data rate specifications in the “Transceiver Specifications for Stratix V GX and GS Devices” table.</li> <li>■ Changed the configuration .rbf sizes in the “Uncompressed .rbf Sizes for Stratix V Devices” table.</li> </ul>  |
| July 2015     | 3.4     | <ul style="list-style-type: none"> <li>■ Changed the data rate specification for transceiver speed grade 3 in the following tables: <ul style="list-style-type: none"> <li>■ “Transceiver Specifications for Stratix V GX and GS Devices”</li> <li>■ “Stratix V Standard PCS Approximate Maximum Date Rate”</li> <li>■ “Stratix V 10G PCS Approximate Maximum Data Rate”</li> </ul> </li> <li>■ Changed the conditions for reference clock rise and fall time, and added a note to the “Transceiver Specifications for Stratix V GX and GS Devices” table.</li> <li>■ Added a note to the “Minimum differential eye opening at receiver serial input pins” specification in the “Transceiver Specifications for Stratix V GX and GS Devices” table.</li> <li>■ Changed the <math>t_{CO}</math> maximum value in the “AS Timing Parameters for AS ‘1 and AS ‘4 Configurations in Stratix V Devices” table.</li> <li>■ Removed the CDR ppm tolerance specification from the “Transceiver Specifications for Stratix V GX and GS Devices” table.</li> </ul>  |

**Table 61. Document Revision History (Part 3 of 3)**

| Date          | Version | Changes  |
|---------------|---------|--|
| May 2013      | 2.7     | <ul style="list-style-type: none"> <li>■ Updated Table 2, Table 6, Table 7, Table 20, Table 23, Table 27, Table 47, Table 60</li> <li>■ Added Table 24, Table 48</li> <li>■ Updated Figure 9, Figure 10, Figure 11, Figure 12</li> </ul>   |
| February 2013 | 2.6     | <ul style="list-style-type: none"> <li>■ Updated Table 7, Table 9, Table 20, Table 23, Table 27, Table 30, Table 31, Table 35, Table 46</li> <li>■ Updated “Maximum Allowed Overshoot and Undershoot Voltage”</li> </ul>   |
| December 2012 | 2.5     | <ul style="list-style-type: none"> <li>■ Updated Table 3, Table 6, Table 7, Table 8, Table 23, Table 24, Table 25, Table 27, Table 30, Table 32, Table 35</li> <li>■ Added Table 33</li> <li>■ Added “Fast Passive Parallel Configuration Timing”</li> <li>■ Added “Active Serial Configuration Timing”</li> <li>■ Added “Passive Serial Configuration Timing”</li> <li>■ Added “Remote System Upgrades”</li> <li>■ Added “User Watchdog Internal Circuitry Timing Specification”</li> <li>■ Added “Initialization”</li> <li>■ Added “Raw Binary File Size”</li> </ul> |
| June 2012     | 2.4     | <ul style="list-style-type: none"> <li>■ Added Figure 1, Figure 2, and Figure 3.</li> <li>■ Updated Table 1, Table 2, Table 3, Table 6, Table 11, Table 22, Table 23, Table 27, Table 29, Table 30, Table 31, Table 32, Table 35, Table 38, Table 39, Table 40, Table 41, Table 43, Table 56, and Table 59.</li> <li>■ Various edits throughout to fix bugs.</li> <li>■ Changed title of document to <i>Stratix V Device Datasheet</i>.</li> <li>■ Removed document from the Stratix V handbook and made it a separate document.</li> </ul>                            |
| February 2012 | 2.3     | <ul style="list-style-type: none"> <li>■ Updated Table 1–22, Table 1–29, Table 1–31, and Table 1–31.</li> </ul>  |
| December 2011 | 2.2     | <ul style="list-style-type: none"> <li>■ Added Table 2–31.</li> <li>■ Updated Table 2–28 and Table 2–34.</li> </ul>  |
| November 2011 | 2.1     | <ul style="list-style-type: none"> <li>■ Added Table 2–2 and Table 2–21 and updated Table 2–5 with information about Stratix V GT devices.</li> <li>■ Updated Table 2–11, Table 2–13, Table 2–20, and Table 2–25.</li> <li>■ Various edits throughout to fix SPRs.</li> </ul>  |
| May 2011      | 2.0     | <ul style="list-style-type: none"> <li>■ Updated Table 2–4, Table 2–18, Table 2–19, Table 2–21, Table 2–22, Table 2–23, and Table 2–24.</li> <li>■ Updated the “DQ Logic Block and Memory Output Clock Jitter Specifications” title.</li> <li>■ Chapter moved to Volume 1.</li> <li>■ Minor text edits.</li> </ul>   |
| December 2010 | 1.1     | <ul style="list-style-type: none"> <li>■ Updated Table 1–2, Table 1–4, Table 1–19, and Table 1–23.</li> <li>■ Converted chapter to the new template.</li> <li>■ Minor text edits.</li> </ul>   |
| July 2010     | 1.0     | Initial release.   |